May 1998

National Semiconductor

DS8921/DS8921A/DS8921AT
Differential Line Driver and Receiver Pair

General Description

The DS8921, DS8921A are Differential Line Driver and Receiver pairs designed specifically for applications meeting the ST506, ST412 and ESDI Disk Drive Standards. In addition, these devices meet the requirements of the EIA Standard RS-422.

The DS8921, DS8921A receivers offer an input sensitivity of 200 mV over a ±7V common mode operating range. Hysteresis is incorporated (typically 70 mV) to improve noise margin for slowly changing input waveforms.

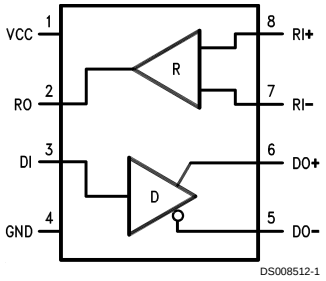
The DS8921, DS8921A drivers are designed to provide unipolar differential drive to twisted pair or parallel wire transmission lines. Complementary outputs are logically ANDed and provide an output skew of 0.5 ns (typ.) with propagation delays of 12 ns.

The DS8921, DS8921A are designed to be compatible with TTL and CMOS.

Features

- 12 ns typical propagation delay
- Output skew - 0.5 ns typical
- Meet the requirements of EIA Standard RS-422
- Complementary Driver Outputs
- High differential or common-mode input voltage ranges of ±7V
- ±0.2V receiver sensitivity over the input voltage range
- Receiver input hysteresis-70 mV typical
- DS8921AT industrial temperature operation: (−40˚C to +85˚C)

Connection Diagram



DS008512-1

Order Number DS8921M, DS8921N, DS8921AM, DS8921AN, DS8921ATM, or DS8921ATN
See NS Package Number M08A or N08E

Truth Table

Receiver		Driver		
Input	V_{OUT}	Input	V_{OUT}	$\overline{V_{OUT}}$
$V_{ID} \geq V_{TH}$ (MAX)	1	1	1	0
$V_{ID} \leq V_{TH}$ (MIN)	0	0	0	1
Open	1			

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	7V
Driver Input Voltage	−0.5V to +7V
Output Voltage	5.5V
Receiver Output Sink Current	50 mA
Receiver Input Voltage	±10V
Differential Input Voltage	±12V
Maximum Package Power Dissipation @ +25˚C	
M Package	730 mW
N Package	1160 mW
Derate M Package	9.3 mW/˚C above +25˚C
Derate N Package	5.8 mW/˚C above +25˚C
Storage Temperature Range	−65˚C to +165˚C
Lead Temperature	+260˚C
(Soldering, 4 sec.)	+260˚C
Maximum Junction Temperature	+150˚C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage	4.5	5.5	V
Temperature (T_A)			
DS8921/DS8921A	0	70	˚C
DS8921AT	−40	+85	˚C

DS8921/DS8921A Electrical Characteristics (Notes 2, 3, 4)

Symbol	Conditions	Min	Typ	Max	Units
RECEIVER					
V_{TH}	$-7V \le V_{CM} \le +7V$	−200	±35	+200	mV
V_{HYST}	$-7V \le V_{CM} \le +7V$	15	70		mV
R_{IN}	V_{IN} = −7V, +7V (Other Input = GND)	4.0	6.0		kΩ
I_{IN}	V_{IN} = 10V			3.25	mA
	V_{IN} = −10V			−3.25	mA
V_{OH}	I_{OH} = −400 µA	2.5			V
V_{OL}	I_{OL} = 8 mA			0.5	V
I_{SC}	V_{CC} = MAX, V_{OUT} = 0V	−15		−100	mA
DRIVER					
V_{IH}		2.0			V
V_{IL}				0.8	V
I_{IL}	V_{CC} = MAX, V_{IN} = 0.4V		−40	−200	µA
I_{IH}	V_{CC} = MAX, V_{IN} = 2.7V			20	µA
I_I	V_{CC} = MAX, V_{IN} = 7.0V			100	µA
V_{CL}	V_{CC} = MIN, I_{IN} = −18 mA			−1.5	V
V_{OH}	V_{CC} = MIN, I_{OH} = −20 mA	2.5			V
V_{OL}	V_{CC} = MIN, I_{OL} = +20 mA			0.5	V
I_{OFF}	V_{CC} = 0V, V_{OUT} = 5.5V			100	µA
$\lvert V_T \rvert - \lvert \overline{VT} \rvert$				0.4	V
V_T		2.0			V
$\lvert V_{OS} - \overline{V_{OS}} \rvert$				0.4	V
I_{SC}	V_{CC} = MAX, V_{OUT} = 0V	−30		−150	mA
DRIVER and RECEIVER					
I_{CC}	V_{CC} = MAX, V_{OUT} = Logic 0			35	mA

Receiver Switching Characteristics

Figure 1(*Figure 2*)

Symbol	Conditions	Min	Typ	Max			Units
				8921	8921A	8921AT	
T_{pLH}	C_L = 30 pF (*Figures 1, 2*)		14	22.5	20	20	ns
T_{pHL}	C_L = 30 pF (*Figures 1, 2*)		14	22.5	20	20	ns
$\|T_{pLH}–T_{pHL}\|$	C_L = 30 pF (*Figures 1, 2*)		0.5	5	3.5	5	ns

Driver Switching Characteristics

SINGLE ENDED CHARACTERISTICS (*Figures 3, 4*)

Symbol	Conditions	Min	Typ	Max			Units
				8921	8921A	8921AT	
T_{pLH}	C_L = 30 pF (*Figures 3, 4*)		10	15	15	15	ns
T_{pHL}	C_L = 30 pF (*Figures 3, 4*)		10	15	15	15	ns
T_{TLH}	C_L = 30 pF (*Figures 7, 8*)		5	8	8	9.5	ns
T_{THL}	C_L = 30 pF (*Figures 7, 8*)		5	8	8	9.5	ns
Skew	CL = 30 pF (*Figures 3, 4*)		1	5	3.5	3.5	ns

Driver Switching Characteristics(Note 6)

DIFFERENTIAL CHARACTERISTICS (*Figures 3, 5*)

Symbol	Conditions	Min	Typ	Max			Units
				8921	8921A	8921AT	
T_{pLH}	C_L = 30 pF (*Figures 3, 5, 6*)		10	15	15	15	ns
T_{pHL}	C_L = 30 pF (*Figures 3, 5, 6*)		10	15	15	15	ns
$\|T_{pLH}–T_{pHL}\|$	C_L = 30 pF (*Figures 3, 5, 6*)		0.5	6	2.75	2.75	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The Table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All currents into device pins are shown as positive values; all currents out of the device are shown as negative; all voltages are referenced to ground unless otherwise specified. All values shown as max or min are classified on absolute value basis.

Note 3: All typical values are V_{CC} = 5V, T_A = 25˚C.

Note 4: Only one output at a time should be shorted.

Note 5: Difference between complementary outputs at the 50% point.

Note 6: Differential Delays are defined as calculated results from single ended rise and fall time measurements. This approach in establishing AC performance specifications has been taken due to limitations of available Automatic Test Equipment (ATE).

The calculated ATE results assume a linear transition between measurement points and are a result of the following equations:

$$T_{cr} = \frac{(T_{fb} \times T_{rb}) - (T_{ra} \times T_{fa})}{T_{rb} - T_{ra} - T_{fa} + T_{fb}}$$

Where: T_{cr} = Crossing Point

T_{ra}, T_{rb}, T_{fa} and T_{fb} are time measurements with respect to the input. See *Figure 6* .

AC Test Circuits and Switching Diagrams

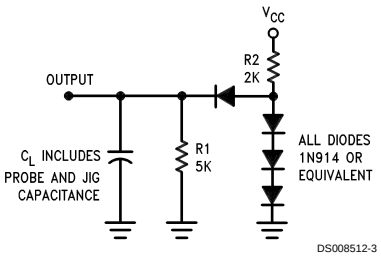


FIGURE 1.

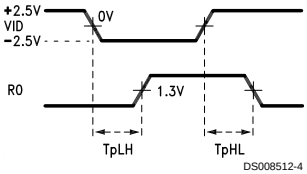


FIGURE 2.

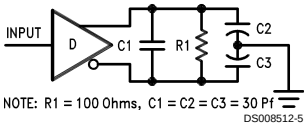


FIGURE 3.

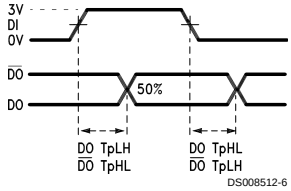


FIGURE 4.

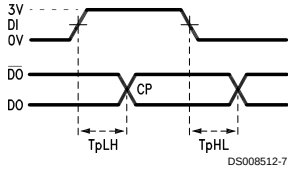


FIGURE 5.

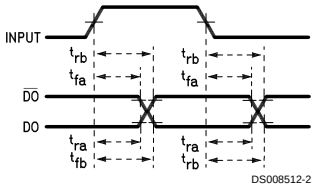


FIGURE 6.

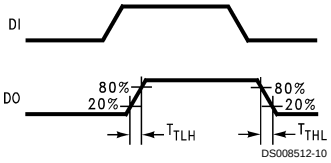


FIGURE 7.

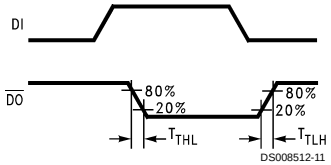
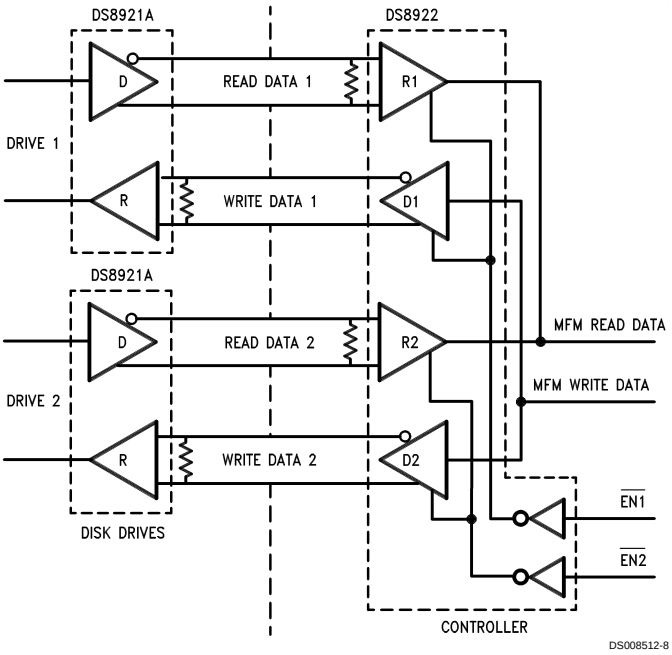


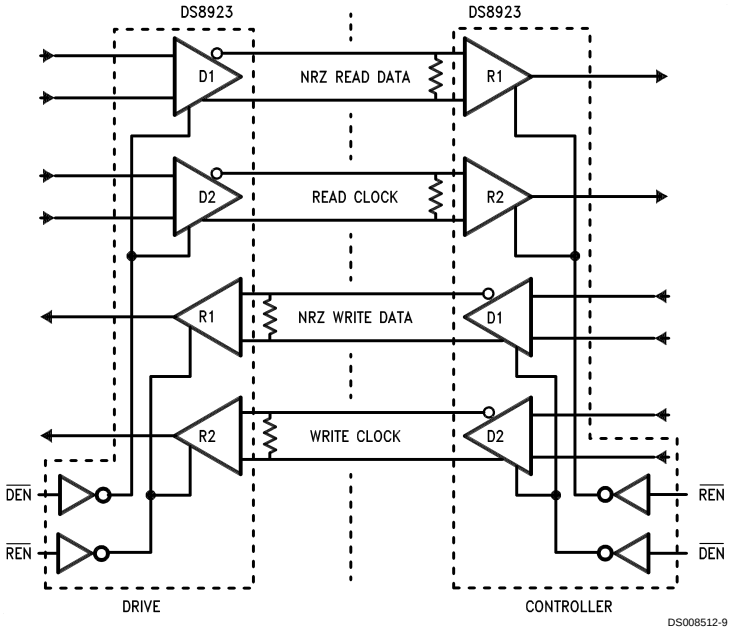
FIGURE 8.

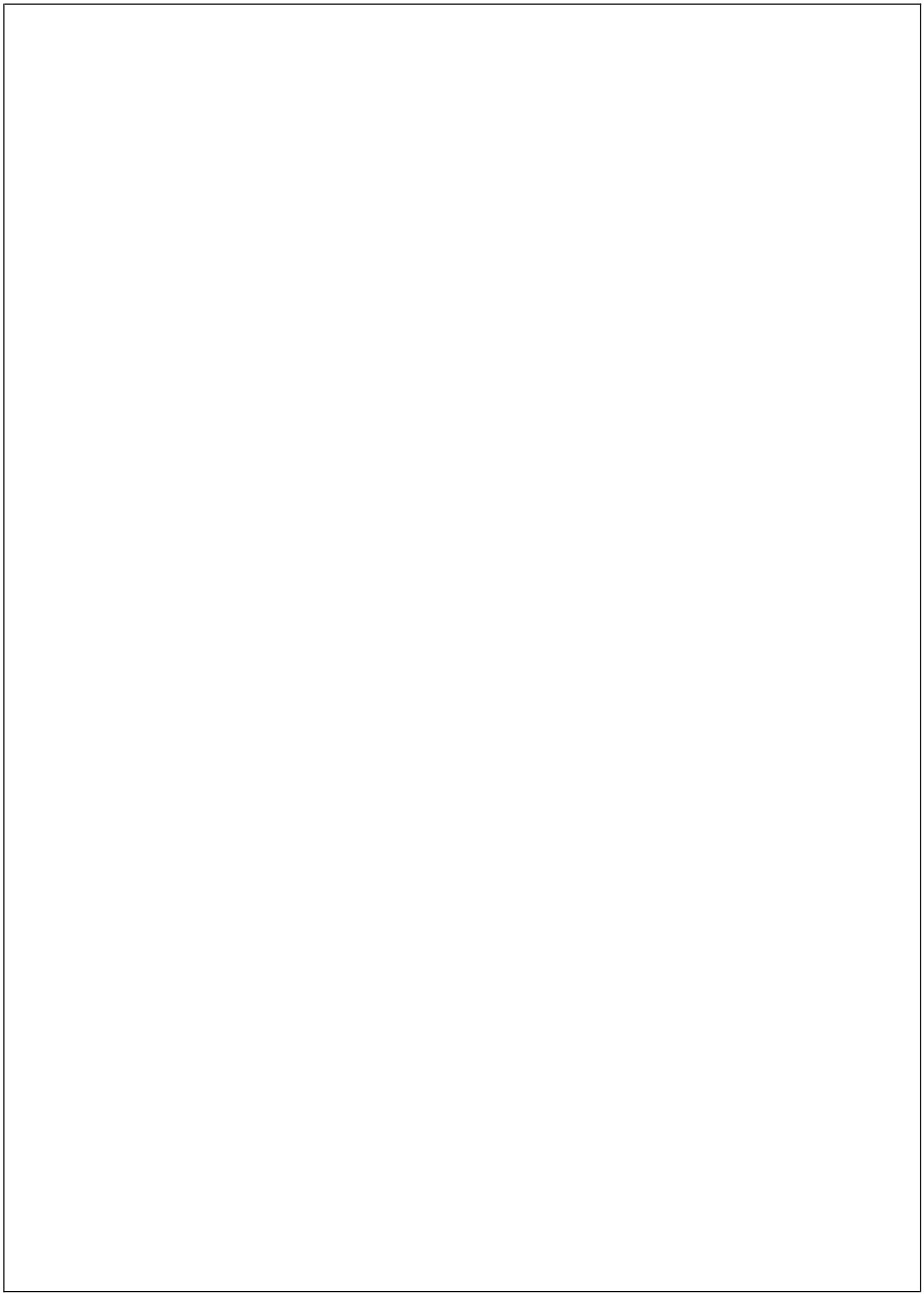
Typical Applications

ST506 and ST412 Application

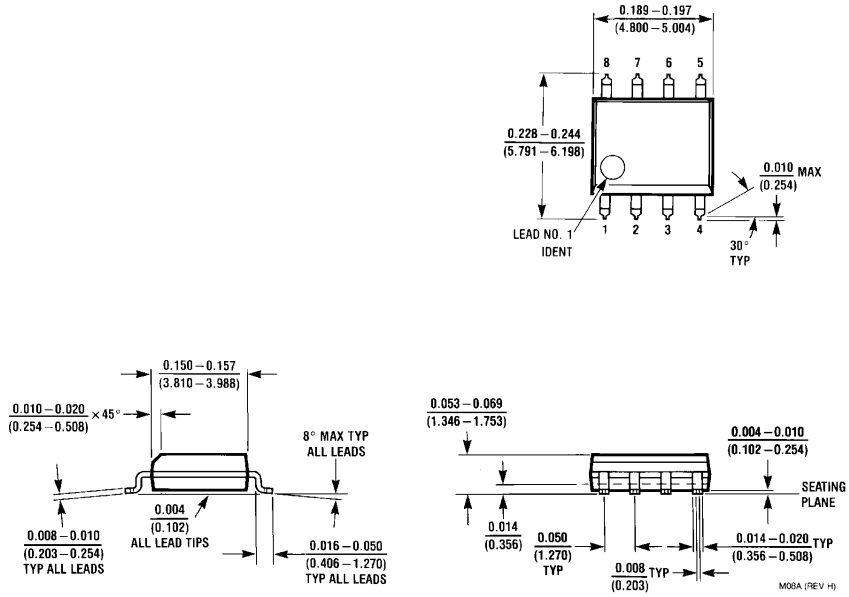


ESDI Application

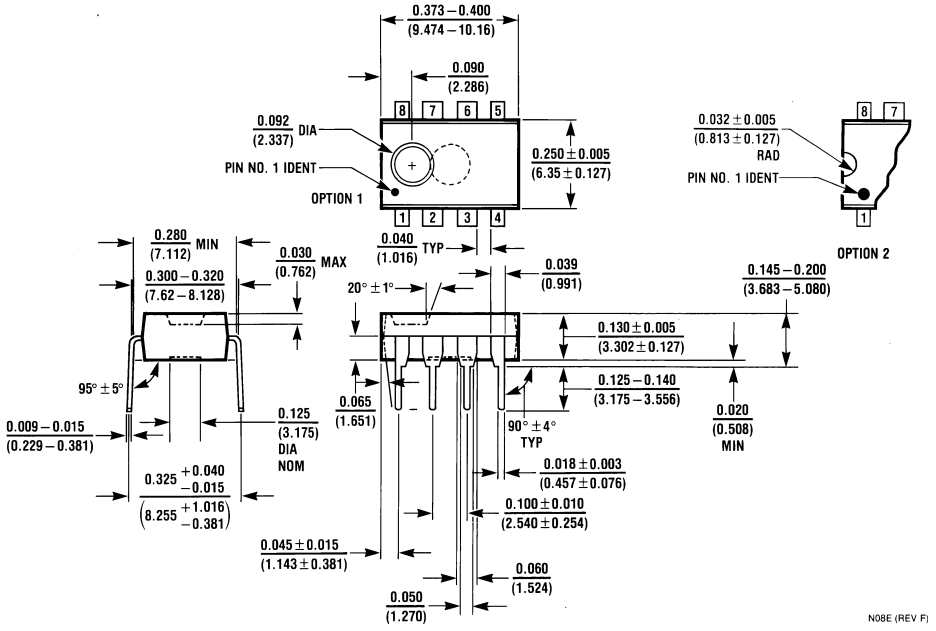




Physical Dimensions inches (millimeters) unless otherwise noted



SO Package (M)
Order Number DS8921M, DS8921AM or DS8921ATM
NS Package Number M08A



Molded Dual-In-Line Package (N)
Order Number DS8921N, DS8921AN or DS8921ATN
NS Package Number N08E

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National Semiconductor Corporation
Americas
Tel: 1-800-272-9959
Fax: 1-800-737-7018
Email: support@nsc.com

www.national.com

National Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 1 80-530 85 85
English Tel: +49 (0) 1 80-532 78 32
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Italiano Tel: +49 (0) 1 80-534 16 80

National Semiconductor Asia Pacific Customer Response Group
Tel: 65-2544466
Fax: 65-2504466
Email: sea.support@nsc.com

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